

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
3. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
4. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.

